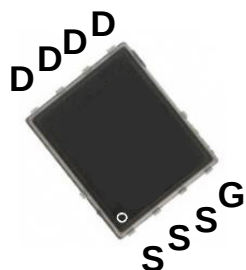
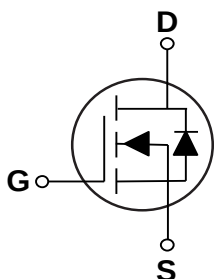


40V N-Channel MOSFETs



PPAK5X6



BV_{DSS}	$R_{DS(ON)}$	I_D
40 V	3.8 mΩ	92 A

Features

- $R_{DS(ON)} \leq 3.8 \text{ m}\Omega @ V_{GS}=10\text{V}$
- Fast switching speed
- Surface mount package
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- AEC-Q101 qualified

Applications

- DC-DC Converters
- Motor Control.
- Portable equipment application

Absolute Maximum Ratings $T_J=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	40	V
V_{GS}	Gate-Source Voltage	± 20	V
I_S	Diode Continuous Forward Current	32	A
I_{DM}	Pulse Drain Current Tested (NOTE 1) ($T_C=25^\circ\text{C}$)	103	A
I_D	Drain Current - Continuous ($T_A=25^\circ\text{C}$)	20	A
	Drain Current - Continuous ($T_A=70^\circ\text{C}$)	17	A
	Drain Current - Continuous ($T_C=25^\circ\text{C}$)	92	A
P_D	Maximum Power Dissipation ($T_C=25^\circ\text{C}$)	50	W
I_{AS}	Avalanche Current, Single pulse ($L=0.1\text{mH}$)	15	A
E_{AS}	Avalanche Energy, Single pulse ($L=0.1\text{mH}$)	11.25	mJ
T_J	Maximum Junction Temperature	175	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-50 to 175	$^\circ\text{C}$
Marking Code		ND3P8	

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient (Steady State)	60	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance Junction to Case (Steady State)	2.5	$^\circ\text{C/W}$

NOTE :

1. Max. current is limited by bonding wire.
2. Continuous current is limited by package.

40V N-Channel MOSFETs

Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	40	---	---	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =32V, V _{GS} =0V	---	---	1	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	---	---	±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =20A	---	3.2	3.8	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.5	---	4	V

Dynamic and switching Characteristics (NOTE 4)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Q _g	Total Gate Charge	V _{DS} =25V, V _{GS} =10V, I _D =14A	---	53.4	---	nC
Q _{gs}	Gate-Source Charge		---	11.8	---	
Q _{gd}	Gate-Drain Charge		---	16.3	---	
T _{d(on)}	Turn-On Delay Time	V _{DS} =15V, V _{GS} =10V, R _{GEN} =1Ω, I _D =1A	---	28	---	nS
T _r	Rise Time		---	21	---	
T _{d(off)}	Turn-Off Delay Time		---	38	---	
T _f	Fall Time		---	19	---	
C _{iss}	Input Capacitance	V _{DS} =20V, V _{GS} =0V, F=1MHz	---	3183	---	pF
C _{oss}	Output Capacitance		---	305	---	
C _{rss}	Reverse Transfer Capacitance		---	183	---	
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz	---	2.9	---	Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V _{SD}	Diode Forward Voltage (NOTE 3)	V _{GS} =0V, I _S =15A	---	0.81	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} =0V, I _F =15A, dI/dt=100A/us	---	19.1	---	nS
Q _{rr}	Reverse Recovery Charge		---	10.4	---	nC

NOTES :

3. Pulse test (pulse width ≤ 300us, duty cycle ≤ 2%).
4. Guaranteed by design, not subject to production testing.

40V N-Channel MOSFETs

Characteristics Curves

FIG. 1-Output Characteristic

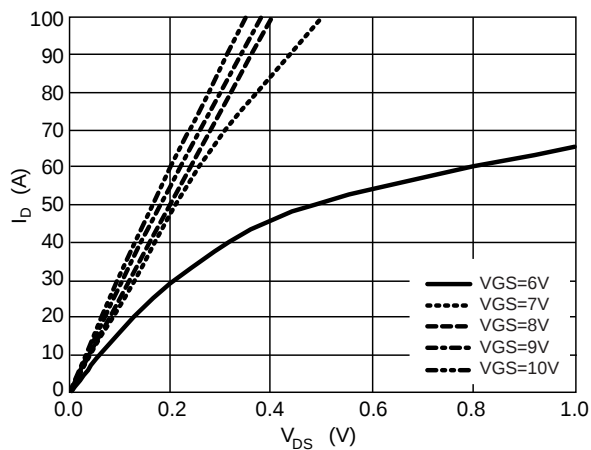


FIG. 2-On-Resistance vs. I_D

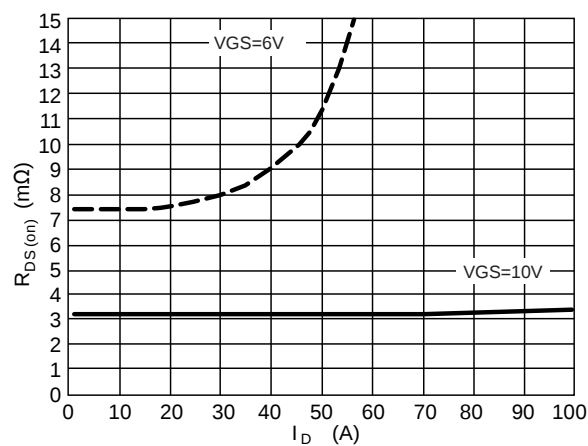


FIG. 3-On-Resistance vs. V_{GS}

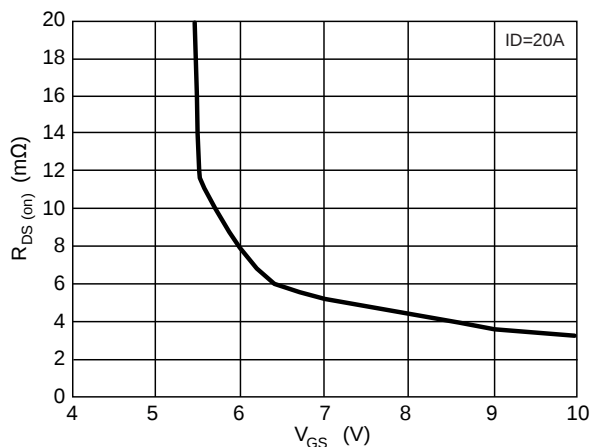


FIG. 4-Source-Drain Diode Forward

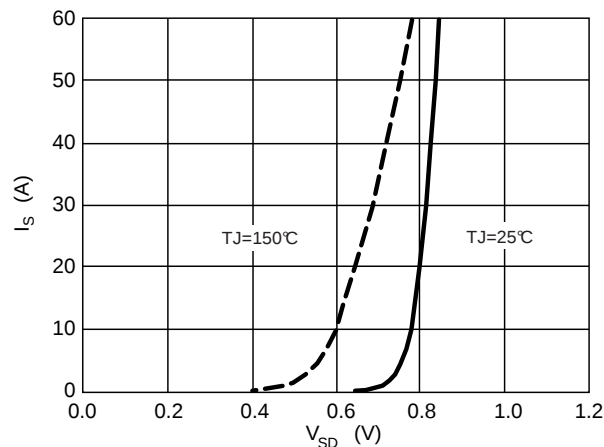


FIG. 5-Gate Charge Characteristics

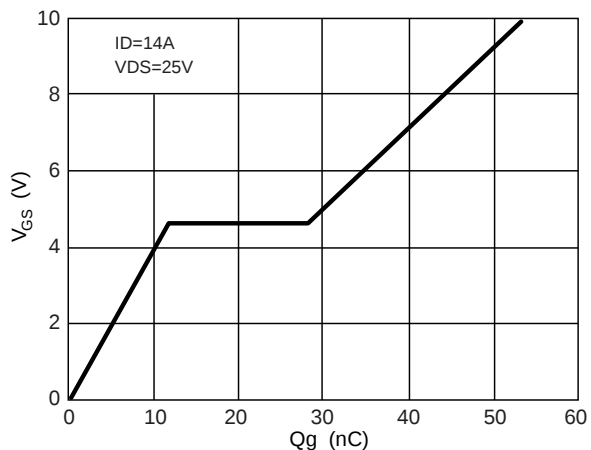
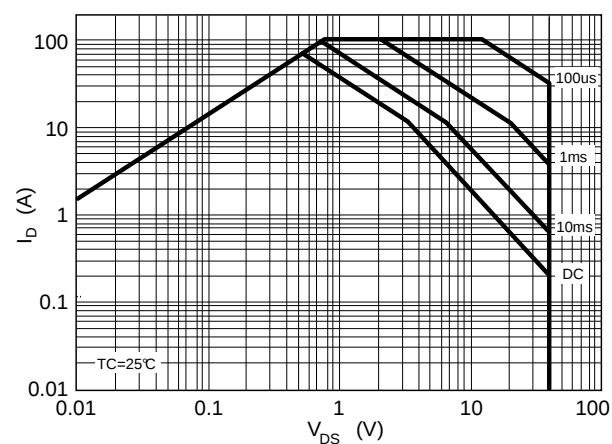


FIG. 6-Safe Operating Area



Characteristics Curves

FIG. 7-Normalized Transient Impedance

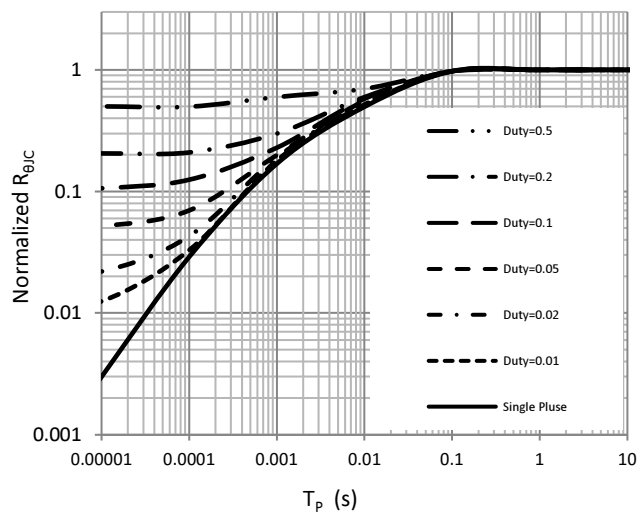


FIG. 8-Capacitance

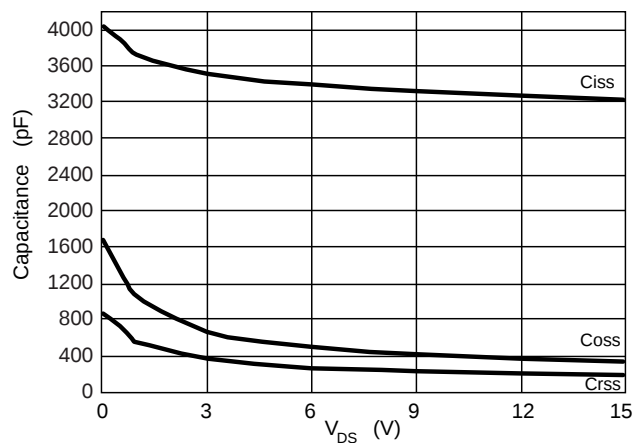


FIG. 9-Normalized $R_{DS(ON)}$ vs. T_J

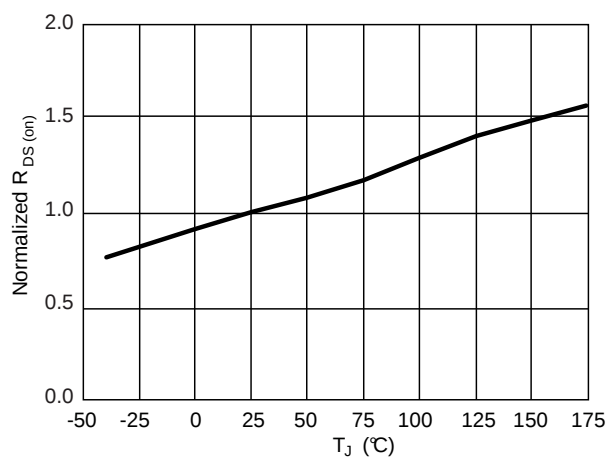
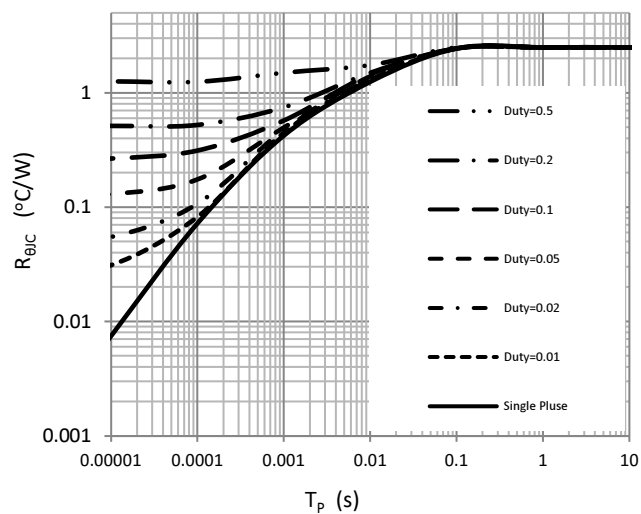
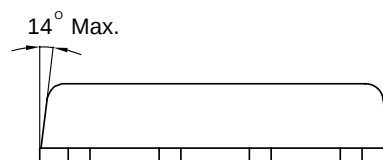
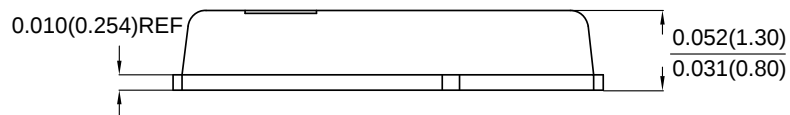
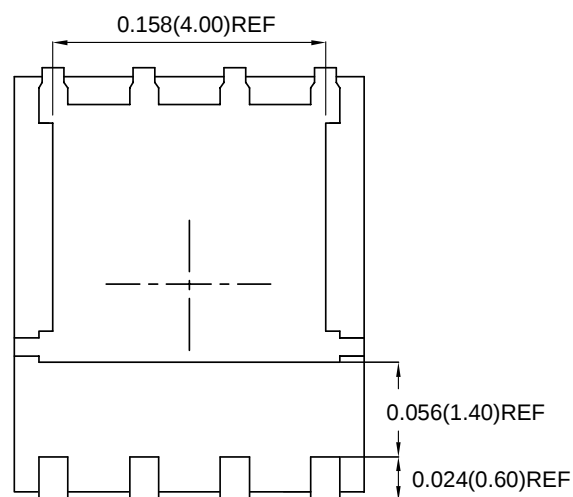
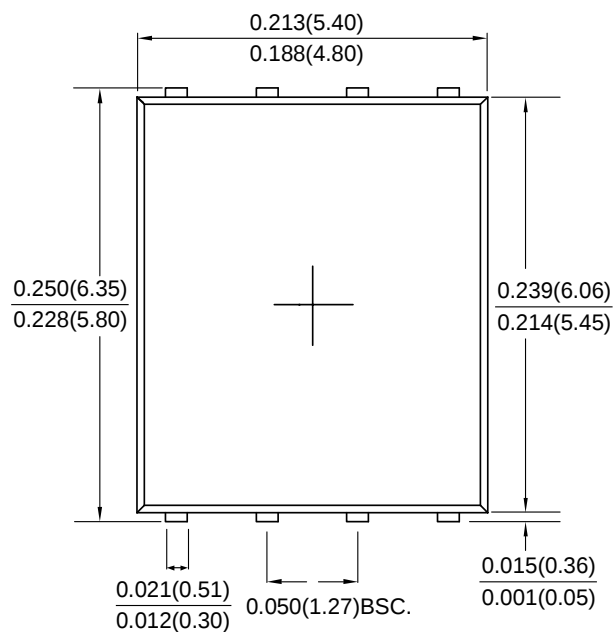


FIG. 10-Max. Transient Thermal Impedance



Package Outline Dimensions



PPAK5X6

Dimensions in inches and (millimeters)

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